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## PATENT APPLICATION TRANSMITTAL LETTER

(Large Entity)

Docket No.  
FIS920000242US1

## TO THE ASSISTANT COMMISSIONER FOR PATENTS

Transmitted herewith for filing under 35 U.S.C. 111 and 37 C.F.R. 1.53 is the patent application of:

Lloyd G. Burrell, et al.

For: COPPER TO ALUMINUM INTERLAYER INTERCONNECT USING STUD AND VIA LINER

Enclosed are:

- ☒ Certificate of Mailing with Express Mail Mailing Label No. EK140407400US
- ☒ 2 sheets of drawings.
- ☐ A certified copy of a application.
- ☒ Declaration ☒ Signed. ☐ Unsigned.
- ☒ Power of Attorney
- ☐ Information Disclosure Statement
- ☐ Preliminary Amendment
- ☒ Other: Assignment for Recordation

## CLAIMS AS FILED

For	#Filed	#Allowed	#Extra	Rate	Fee
Total Claims	16	- 20 =	0	x \$18.00	\$0.00
Indep. Claims	2	- 3 =	0	x \$80.00	\$0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					\$0.00
BASIC FEE					\$710.00
TOTAL FILING FEE					\$710.00

- ☐ A check in the amount of to cover the filing fee is enclosed.
- ☒ The Commissioner is hereby authorized to charge and credit Deposit Account No. 09-0458 FI-123 as described below. A duplicate copy of this sheet is enclosed.
- ☒ Charge the amount of \$710.00 as filing fee.
- ☒ Credit any overpayment.
- ☒ Charge any additional filing fees required under 37 C.F.R. 1.16 and 1.17.
- ☐ Charge the issue fee set in 37 C.F.R. 1.18 at the mailing of the Notice of Allowance, pursuant to 37 C.F.R. 1.311(b).

Dated: March 12, 2001



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CC:

**CERTIFICATE OF MAILING BY "EXPRESS MAIL" (37 CFR 1.10)**Applicant(s): **Lloyd G. Burrell, et al.**

Docket No.

**FIS920000242US1**

Serial No.

Unassigned

Filing Date

Herewith

Examiner

Unassigned

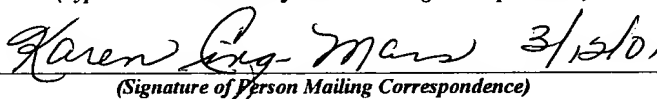
Group Art Unit

Unassigned

Invention: **COPPER TO ALUMINUM INTERLAYER INTERCONNECT USING STUD AND VIA LINER**I hereby certify that this **New Patent Application***(Identify type of correspondence)*

is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under

37 CFR 1.10 in an envelope addressed to: The Assistant Commissioner for Patents, Washington, D.C. 20231

**March 12, 2001***(Date)***Karen Cinq-Mars***(Typed or Printed Name of Person Mailing Correspondence)*Handwritten signature of Karen Cinq-Mars, dated 3/12/01.*(Signature of Person Mailing Correspondence)***EK140407400US***( "Express Mail" Mailing Label Number )***Note: Each paper must have its own certificate of mailing.**

# CERTIFICATE OF MAILING BY "EXPRESS MAIL" (37 CFR 1.10)

Applicant(s): Lloyd G. Burrell, et al.

Docket No.

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Unassigned

Invention: COPPER TO ALUMINUM INTERLAYER INTERCONNECT USING STUD AND VIA LINER

11040 U.S. PRO  
09/805027  
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March 12, 2001

(Date)

Karen Cinq-Mars

(Typed or Printed Name of Person Mailing Correspondence)

Karen Cinq-Mars 3/12/01

(Signature of Person Mailing Correspondence)

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